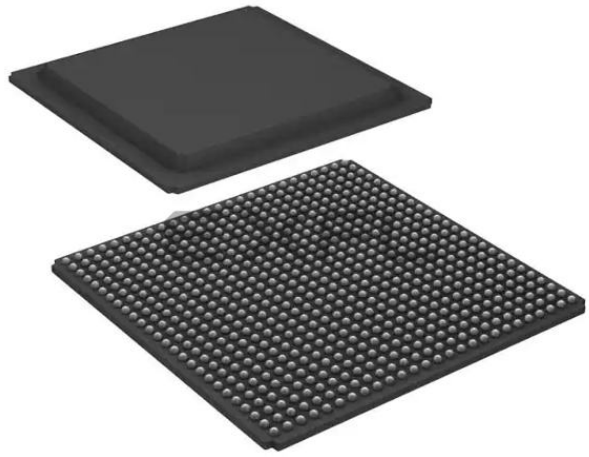

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	17280
Total RAM Bits	442368
Number of I/O	391
Number of Gates	1000000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s1000-4fg676i

Table 3 shows the number of user I/Os as well as the number of differential I/O pairs available for each device/package combination.

Table 3: **Spartan-3 Device I/O Chart**

Available User I/Os and Differential (Diff) I/O Pairs by Package Type																				
Package	**VQ100 VQG100**		**CP132(1) CPG132**		**TQ144 TQG144**		**PQ208 PQG208**		**FT256 FTG256**		**FG320 FGG320**		**FG456 FGG456**		**FG676 FGG676**		**FG900 FGG900**		**FG1156(1) FGG1156**	
Footprint (mm)	**16 x 16**		**8 x 8**		**22 x 22**		**30.6 x 30.6**		**17 x 17**		**19 x 19**		**23 x 23**		**27 x 27**		**31 x 31**		**35 x 35**	
Device	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**	**User**	**Diff**
XC3S50	63	29	89(1)	44(1)	97	46	124	56	–	–	–	–	–	–	–	–	–	–	–	–
XC3S200	63	29	–	–	97	46	141	62	173	76	–	–	–	–	–	–	–	–	–	–
XC3S400	–	–	–	–	97	46	141	62	173	76	221	100	264	116	–	–	–	–	–	–
XC3S1000	–	–	–	–	–	–	–	–	173	76	221	100	333	149	391	175	–	–	–	–
XC3S1500	–	–	–	–	–	–	–	–	–	–	221	100	333	149	487	221	–	–	–	–
XC3S2000	–	–	–	–	–	–	–	–	–	–	–	–	333	149	489	221	565	270	–	–
XC3S4000	–	–	–	–	–	–	–	–	–	–	–	–	–	–	489	221	633	300	712(1)	312(1)
XC3S5000	–	–	–	–	–	–	–	–	–	–	–	–	–	–	489	221	633	300	784(1)	344(1)

Notes:

1. The CP132, CPG132, FG1156, and FGG1156 packages are discontinued. See http://www.xilinx.com/support/documentation/spartan-3_customer_notices.htm.
2. All device options listed in a given package column are pin-compatible.
3. User = Single-ended user I/O pins. Diff = Differential I/O pairs.

Package Marking

Figure 2 shows the top marking for Spartan-3 FPGAs in the quad-flat packages. Figure 3 shows the top marking for Spartan-3 FPGAs in BGA packages except the 132-ball chip-scale package (CP132 and CPG132). The markings for the BGA packages are nearly identical to those for the quad-flat packages, except that the marking is rotated with respect to the ball A1 indicator. Figure 4 shows the top marking for Spartan-3 FPGAs in the CP132 and CPG132 packages.

The "5C" and "4I" part combinations may be dual marked as "5C/4I". Devices with the dual mark can be used as either -5C or -4I devices. Devices with a single mark are only guaranteed for the marked speed grade and temperature range. Some specifications vary according to mask revision. Mask revision E devices are errata-free. All shipments since 2006 have been mask revision E.

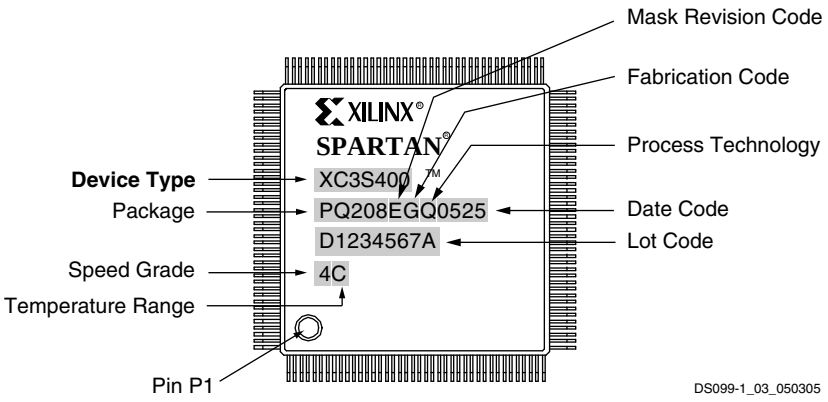


Figure 2: **Spartan-3 FPGA QFP Package Marking Example for Part Number XC3S400-4PQ208C**

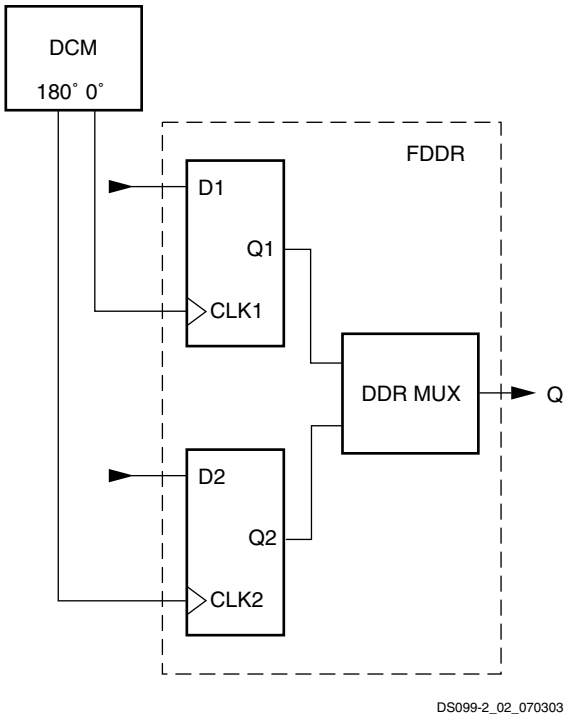


Figure 8: **Clocking the DDR Register**

Aside from high bandwidth data transfers, DDR can also be used to reproduce, or “mirror”, a clock signal on the output. This approach is used to transmit clock and data signals together. A similar approach is used to reproduce a clock signal at multiple outputs. The advantage for both approaches is that skew across the outputs will be minimal.

Some adjacent I/O blocks (IOBs) share common routing connecting the ICLK1, ICLK2, OTCLK1, and OTCLK2 clock inputs of both IOBs. These IOB pairs are identified by their differential pair names IO_LxxN_# and IO_LxxP_#, where "xx" is an I/O pair number and ‘#’ is an I/O bank number. Two adjacent IOBs containing DDR registers must share common clock inputs, otherwise one or more of the clock signals will be unroutable.

Pull-Up and Pull-Down Resistors

The optional pull-up and pull-down resistors are intended to establish High and Low levels, respectively, at unused I/Os. The pull-up resistor optionally connects each IOB pad to V_{CCO}. A pull-down resistor optionally connects each pad to GND. These resistors are placed in a design using the PULLUP and PULLDOWN symbols in a schematic, respectively. They can also be instantiated as components, set as constraints or passed as attributes in HDL code. These resistors can also be selected for all unused I/O using the Bitstream Generator (BitGen) option UnusedPin. A Low logic level on HSWAP_EN activates the pull-up resistors on all I/Os during configuration (see The I/Os During Power-On, Configuration, and User Mode, page 21).

The Spartan-3 FPGAs I/O pull-up and pull-down resistors are significantly stronger than the "weak" pull-up/pull-down resistors used in previous Xilinx FPGA families. See Table 33, page 61 for equivalent resistor strengths.

Keeper Circuit

Each I/O has an optional keeper circuit that retains the last logic level on a line after all drivers have been turned off. This is useful to keep bus lines from floating when all connected drivers are in a high-impedance state. This function is placed in a design using the KEEPER symbol. Pull-up and pull-down resistors override the keeper circuit.

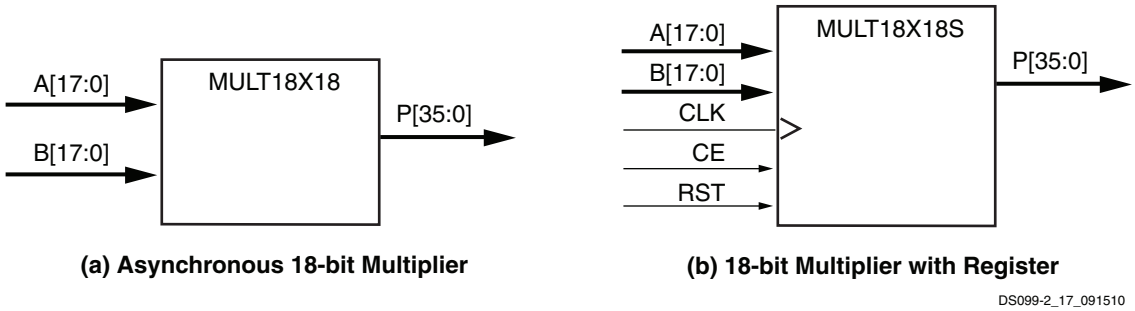


Figure 18: **Embedded Multiplier Primitives**

Table 15: **Embedded Multiplier Primitives Descriptions**

Signal Name	Direction	Function
A[17:0]	Input	Apply one 18-bit multiplicand to these inputs. The MULT18X18S primitive requires a setup time before the enabled rising edge of CLK.
B[17:0]	Input	Apply the other 18-bit multiplicand to these inputs. The MULT18X18S primitive requires a setup time before the enabled rising edge of CLK.
P[35:0]	Output	The output on the P bus is a 36-bit product of the multiplicands A and B. In the case of the MULT18X18S primitive, an enabled rising CLK edge updates the P bus.
CLK	Input(1)	CLK is only an input to the MULT18X18S primitive. The clock signal applied to this input, when enabled by CE, updates the output register that drives the P bus.
CE	Input(1)	CE is only an input to the MULT18X18S primitive. Enable for the CLK signal. Asserting this input enables the CLK signal to update the P bus.
RST	Input(1)	RST is only an input to the MULT18X18S primitive. Asserting this input resets the output register on an enabled, rising CLK edge, forcing the P bus to all zeroes.

Notes:

1. The control signals CLK, CE and RST have the option of inverted polarity.

Digital Clock Manager (DCM)

Spartan-3 devices provide flexible, complete control over clock frequency, phase shift and skew through the use of the DCM feature. To accomplish this, the DCM employs a Delay-Locked Loop (DLL), a fully digital control system that uses feedback to maintain clock signal characteristics with a high degree of precision despite normal variations in operating temperature and voltage. This section provides a fundamental description of the DCM. For further information, refer to the chapter entitled “Using Digital Clock Managers” in UG331.

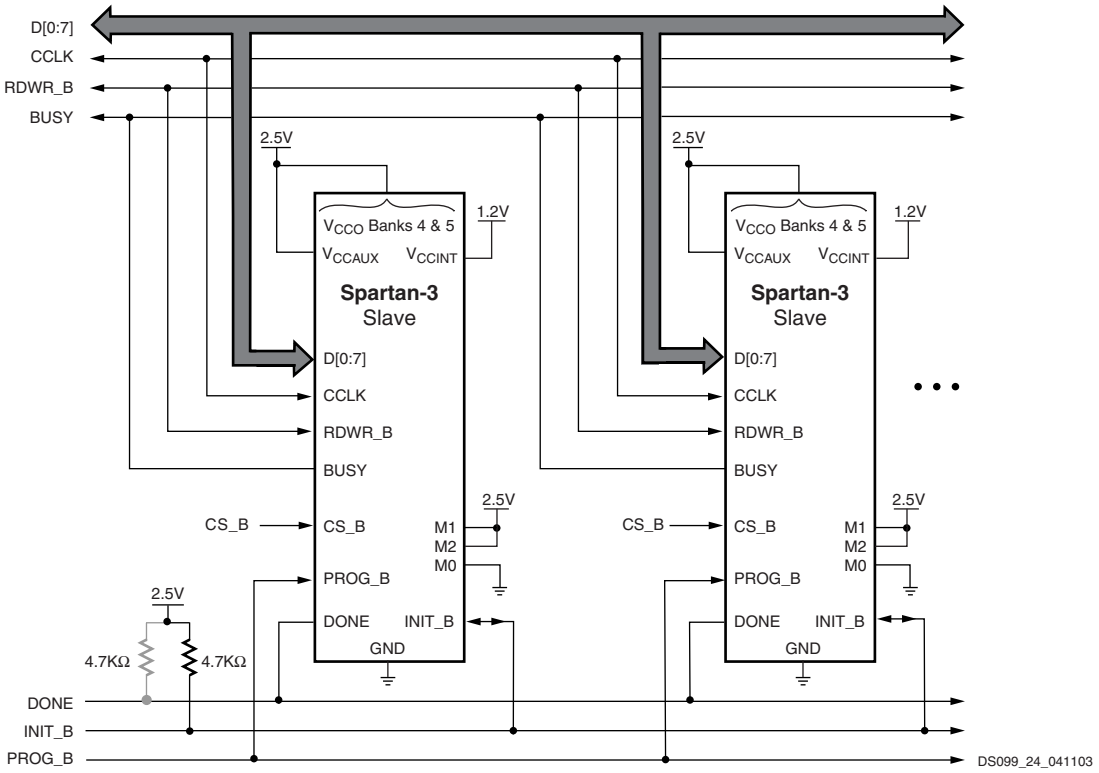
Each member of the Spartan-3 family has four DCMs, except the smallest, the XC3S50, which has two DCMs. The DCMs are located at the ends of the outermost Block RAM column(s). See Figure 1, page 3. The Digital Clock Manager is placed in a design as the “DCM” primitive.

The DCM supports three major functions:

- **Clock-skew Elimination:** Clock skew describes the extent to which clock signals may, under normal circumstances, deviate from zero-phase alignment. It occurs when slight differences in path delays cause the clock signal to arrive at different points on the die at different times. This clock skew can increase set-up and hold time requirements as well as clock-to-out time, which may be undesirable in applications operating at a high frequency, when timing is critical. The DCM eliminates clock skew by aligning the output clock signal it generates with another version of the clock signal that is fed back. As a result, the two clock signals establish a zero-phase relationship. This effectively cancels out clock distribution delays that may lie in the signal path leading from the clock output of the DCM to its feedback input.
- **Frequency Synthesis:** Provided with an input clock signal, the DCM can generate a wide range of different output clock frequencies. This is accomplished by either multiplying and/or dividing the frequency of the input clock signal by any of several different factors.

(e.g. all configuration pins taken together) when operating in the User mode. This is accomplished by setting the *Persist* option to *Yes*.

Multiple FPGAs can be configured using the Slave Parallel mode and can be made to start-up simultaneously. Figure 27 shows the device connections. To configure multiple devices in this way, wire the individual CCLK, Data, RDWR_B, and BUSY pins of all the devices in parallel. The individual devices are loaded separately by deasserting the CS_B pin of each device in turn and writing the appropriate data.



Notes:

1. There are two ways to use the DONE line. First, one may set the BitGen option DriveDone to "Yes" only for the last FPGA to be configured in the chain shown above (or for the single FPGA as may be the case). This enables the DONE pin to drive High; thus, no pull-up resistor is necessary. DriveDone is set to "No" for the remaining FPGAs in the chain. Second, DriveDone can be set to "No" for all FPGAs. Then all DONE lines are open-drain and require the pull-up resistor shown in grey. In most cases, a value between 3.3KΩ to 4.7KΩ is sufficient. However, when using DONE synchronously with a long chain of FPGAs, cumulative capacitance may necessitate lower resistor values (e.g. down to 330Ω) in order to ensure a rise time within one clock cycle.
2. If the FPGAs use different configuration data files, configure them in sequence by first asserting the CS_B of one FPGA then asserting the CS_B of the other FPGA.
3. For information on how to program the FPGA using 3.3V signals and power, see 3.3V-Tolerant Configuration Interface.

Figure 27: **Connection Diagram for Slave Parallel Configuration**

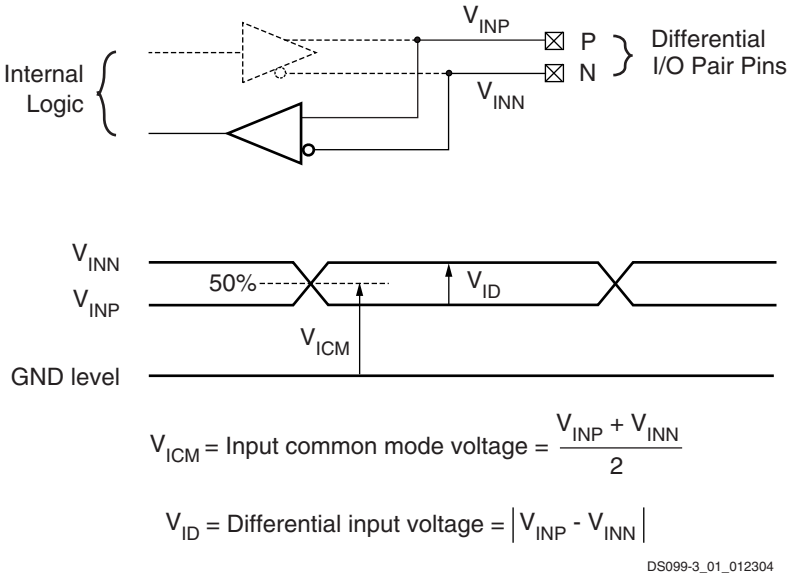


Figure 32: **Differential Input Voltages**

Table 37: **Recommended Operating Conditions for User I/Os Using Differential Signal Standards**

Signal Standard (IOSTANDARD)	V_{CCO}[1]			V_{ID}[3]			V_{ICM}		
	Min (V)	Nom (V)	Max (V)	Min (mV)	Nom (mV)	Max (mV)	Min (V)	Nom (V)	Max (V)
LDT_25 (ULVDS_25)	2.375	2.50	2.625	200	600	1000	0.44	0.60	0.78
LVDS_25, LVDS_25_DCI	2.375	2.50	2.625	100	350	600	0.30	1.25	2.20
BLVDS_25	2.375	2.50	2.625	-	350	-	-	1.25	-
LVDSEXT_25, LVDSEXT_25_DCI	2.375	2.50	2.625	100	540	1000	0.30	1.20	2.20
LVPECL_25	2.375	2.50	2.625	100	-	-	0.30	1.20	2.00
RSDS_25	2.375	2.50	2.625	100	200	-	-	1.20	-
DIFF_HSTL_II_18, DIFF_HSTL_II_18_DCI	1.70	1.80	1.90	200	-	-	0.80	-	1.00
DIFF_SSTL2_II, DIFF_SSTL2_II_DCI	2.375	2.50	2.625	300	-	-	1.05	-	1.45

Notes:

1. V_{CCO} only supplies differential output drivers, not input circuits.
2. V_{REF} inputs are not used for any of the differential I/O standards.
3. V_{ID} is a differential measurement.

Table 47: **Output Timing Adjustments for IOB *(Cont'd)***

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS18	Slow	2 mA	5.49	6.31	ns
		4 mA	3.45	3.97	ns
		6 mA	2.84	3.26	ns
		8 mA	2.62	3.01	ns
		12 mA	2.11	2.43	ns
		16 mA	2.07	2.38	ns
	Fast	2 mA	2.50	2.88	ns
		4 mA	1.15	1.32	ns
		6 mA	0.96	1.10	ns
		8 mA	0.87	1.01	ns
		12 mA	0.79	0.91	ns
		16 mA	0.76	0.87	ns
LVDCI_18			0.81	0.94	ns
LVDCI_DV2_18			0.67	0.77	ns
LVCMOS25	Slow	2 mA	6.43	7.39	ns
		4 mA	4.15	4.77	ns
		6 mA	3.38	3.89	ns
		8 mA	2.99	3.44	ns
		12 mA	2.53	2.91	ns
		16 mA	2.50	2.87	ns
		24 mA	2.22	2.55	ns
	Fast	2 mA	3.27	3.76	ns
		4 mA	1.87	2.15	ns
		6 mA	0.32	0.37	ns
		8 mA	0.19	0.22	ns
		12 mA	0	0	ns
		16 mA	–0.02	–0.01	ns
		24 mA	–0.04	–0.02	ns
LVDCI_25			0.27	0.31	ns
LVDCI_DV2_25			0.16	0.19	ns

Table 67: **Timing for the Master and Slave Parallel Configuration Modes *(Cont'd)***

Symbol	Description			Slave/ Master	All Speed Grades		Units
					Min	Max	
Clock Timing							
T_{CCH}	CCLK input pin High pulse width			Slave	5	∞	ns
T_{CCL}	CCLK input pin Low pulse width				5	∞	ns
F_{CCPAR}	Frequency of the clock signal at the CCLK input pin	No bitstream compression	Not using the BUSY pin(4)		0	50	MHz
			Using the BUSY pin		0	66	MHz
		With bitstream compression			0	20	MHz
		During STARTUP phase			0	50	MHz
ΔF_{CCPAR}	Variation from the CCLK output frequency set using the BitGen option ConfigRate			Master	–50%	+50%	–

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 32.
2. Some Xilinx documents may refer to Parallel modes as "SelectMAP" modes.
3. RDWR_B is synchronized to CCLK for the purpose of performing the Abort operation. The same pin asynchronously controls the driver impedance of the D0 - D7 pins. To avoid contention when writing configuration data to the D0 - D7 bus, do not bring RDWR_B High when CS_B is Low.
4. In the Slave Parallel mode, it is necessary to use the BUSY pin when the CCLK frequency exceeds this maximum specification.

Table 70: **Spartan-3 FPGA Pin Definitions *(Cont'd)***

Pin Name	Direction	Description
GCLK: Global clock buffer inputs		
IO_Lxxy_#/GCLK0, IO_Lxxy_#/GCLK1, IO_Lxxy_#/GCLK2, IO_Lxxy_#/GCLK3, IO_Lxxy_#/GCLK4, IO_Lxxy_#/GCLK5, IO_Lxxy_#/GCLK6, IO_Lxxy_#/GCLK7	Input if connected to global clock buffers Otherwise, same as I/O	**Global Buffer Input:** Direct input to a low-skew global clock buffer. If not connected to a global clock buffer, this pin is a user I/O.
VREF: I/O bank input reference voltage pins		
IO_Lxxy_#/VREF_# or IO/VREF_#	Voltage supply input when VREF pins are used within a bank. Otherwise, same as I/O	**Input Buffer Reference Voltage for Special I/O Standards (per bank):** If required to support special I/O standards, all the VREF pins within a bank connect to a input threshold voltage source. If not used as input reference voltage pins, these pins are available as individual user-I/O pins.
CONFIG: Dedicated configuration pins (pull-up resistor to VCCAUX always active during configuration, regardless of HSWAP_EN pin)		
CCLK	Input in Slave configuration modes Output in Master configuration modes	**Configuration Clock:** The configuration clock signal synchronizes configuration data. This pin has an internal pull-up resistor to VCCAUX during configuration.
PROG_B	Input	**Program/Configure Device:** Active Low asynchronous reset to configuration logic. Asserting PROG_B Low for an extended period delays the configuration process. This pin has an internal pull-up resistor to VCCAUX during configuration.
DONE	Bidirectional with open-drain or totem-pole Output	**Configuration Done, Delay Start-up Sequence:** A Low-to-High output transition on this bidirectional pin signals the end of the configuration process. The FPGA produces a Low-to-High transition on this pin to indicate that the configuration process is complete. The DriveDone bitstream generation option defines whether this pin functions as a totem-pole output that actively drives High or as an open-drain output. An open-drain output requires a pull-up resistor to produce a High logic level. The open-drain option permits the DONE lines of multiple FPGAs to be tied together, so that the common node transitions High only after all of the FPGAs have completed configuration. Externally holding the open-drain output Low delays the start-up sequence, which marks the transition to user mode.
M0, M1, M2	Input	**Configuration Mode Selection:** These inputs select the configuration mode. The logic levels applied to the mode pins are sampled on the rising edge of INIT_B. See Table 75. These pins have an internal pull-up resistor to VCCAUX during configuration, making Slave Serial the default configuration mode.
HSWAP_EN	Input	**Disable Pull-up Resistors During Configuration:** A Low on this pin enables pull-up resistors on all pins that are not actively involved in the configuration process. A High value disables all pull-ups, allowing the non-configuration pins to float.
JTAG: JTAG interface pins (pull-up resistor to VCCAUX always active during configuration, regardless of HSWAP_EN pin)		
TCK	Input	**JTAG Test Clock:** The TCK clock signal synchronizes all JTAG port operations. This pin has an internal pull-up resistor to VCCAUX during configuration.

PQ208 Footprint

Left Half of Package (Top View)

XC3S50
(124 max. user I/O)

72 **I/O:** Unrestricted, general-purpose user I/O

16 **VREF:** User I/O or input voltage reference for bank

17 **N.C.:** Unconnected pins for XC3S50 (◆)

XC3S200, XC3S400
(141 max user I/O)

83 **I/O:** Unrestricted, general-purpose user I/O

22 **VREF:** User I/O or input voltage reference for bank

0 **N.C.:** No unconnected pins in this package

All devices

12 **DUAL:** Configuration pin, then possible user I/O

8 **GCLK:** User I/O or global clock buffer input

16 **DCI:** User I/O or reference resistor input for bank

7 **CONFIG:** Dedicated configuration pins

4 **JTAG:** Dedicated JTAG port pins

4 **VCCINT:** Internal core voltage supply (+1.2V)

12 **VCCO:** Output voltage supply for bank

8 **VCCAUX:** Auxiliary voltage supply (+2.5V)

28 **GND:** Ground

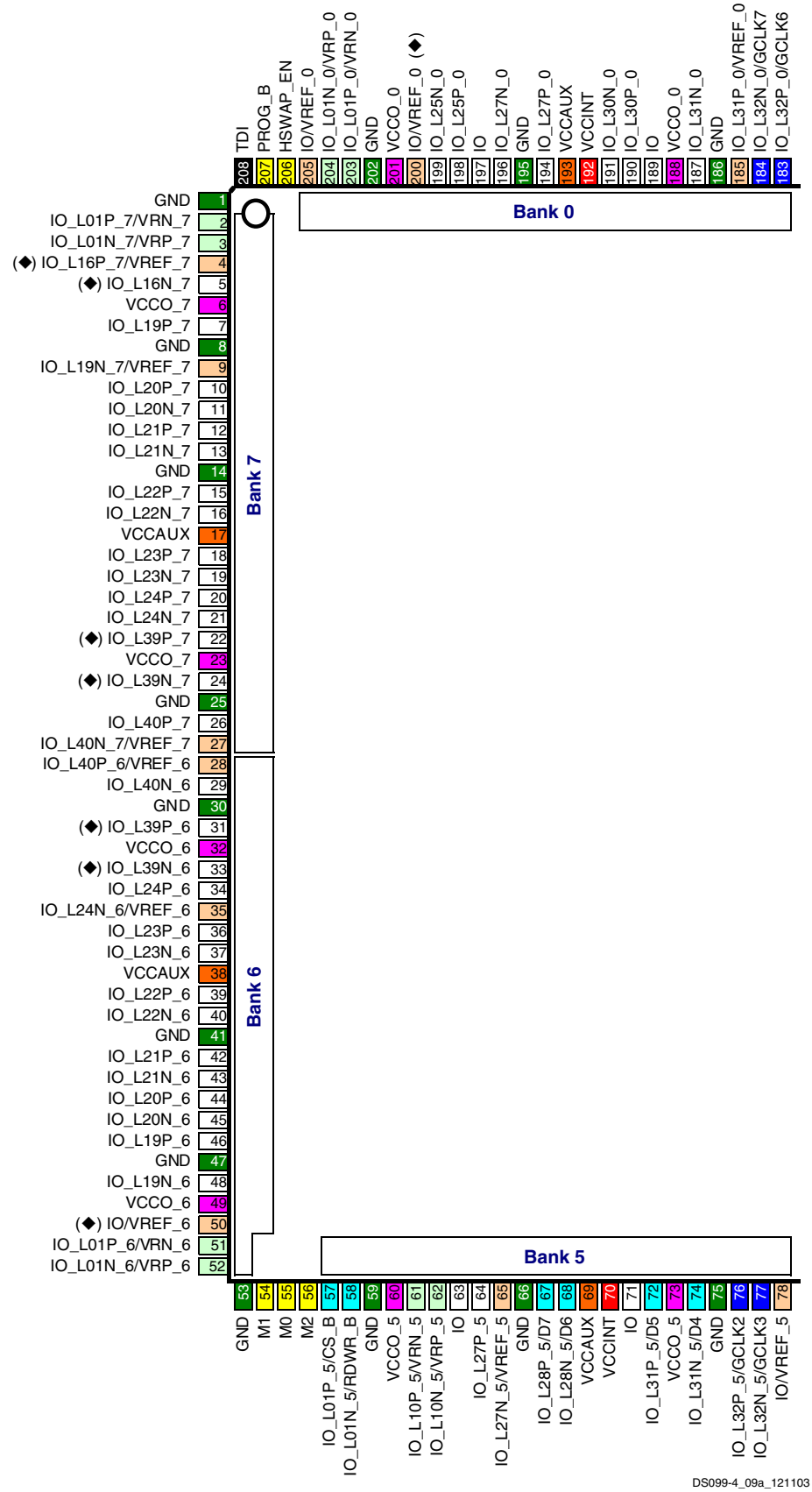


Figure 47: **PQ208 Package Footprint (Top View). Note pin 1 indicator in top-left corner and logo orientation.**

Table 98: **FG320 Package Pinout *(Cont'd)***

Bank	XC3S400, XC3S1000, XC3S1500 Pin Name	FG320 Pin Number	Type
3	IO_L24N_3	M18	I/O
3	IO_L24P_3	N17	I/O
3	IO_L27N_3	L14	I/O
3	IO_L27P_3	L13	I/O
3	IO_L34N_3	L15	I/O
3	IO_L34P_3/VREF_3	L16	VREF
3	IO_L35N_3	L18	I/O
3	IO_L35P_3	L17	I/O
3	IO_L39N_3	K13	I/O
3	IO_L39P_3	K14	I/O
3	IO_L40N_3/VREF_3	K17	VREF
3	IO_L40P_3	K18	I/O
3	VCCO_3	K12	VCCO
3	VCCO_3	L12	VCCO
3	VCCO_3	N16	VCCO
4	IO	P12	I/O
4	IO	V14	I/O
4	IO/VREF_4	R10	VREF
4	IO/VREF_4	U13	VREF
4	IO/VREF_4	V17	VREF
4	IO_L01N_4/VRP_4	U16	DCI
4	IO_L01P_4/VRN_4	V16	DCI
4	IO_L06N_4/VREF_4	P14	VREF
4	IO_L06P_4	R14	I/O
4	IO_L09N_4	U15	I/O
4	IO_L09P_4	V15	I/O
4	IO_L10N_4	T14	I/O
4	IO_L10P_4	U14	I/O
4	IO_L25N_4	R13	I/O
4	IO_L25P_4	P13	I/O
4	IO_L27N_4/DIN/D0	T12	DUAL
4	IO_L27P_4/D1	R12	DUAL
4	IO_L28N_4	V12	I/O
4	IO_L28P_4	V11	I/O
4	IO_L29N_4	R11	I/O
4	IO_L29P_4	T11	I/O
4	IO_L30N_4/D2	N11	DUAL
4	IO_L30P_4/D3	P11	DUAL
4	IO_L31N_4/INIT_B	U10	DUAL

Table 98: **FG320 Package Pinout *(Cont'd)***

Bank	XC3S400, XC3S1000, XC3S1500 Pin Name	FG320 Pin Number	Type
6	IO_L01P_6/VRN_6	T2	DCI
6	IO_L16N_6	U1	I/O
6	IO_L16P_6	T1	I/O
6	IO_L17N_6	R2	I/O
6	IO_L17P_6/VREF_6	R1	VREF
6	IO_L19N_6	R3	I/O
6	IO_L19P_6	P3	I/O
6	IO_L20N_6	P2	I/O
6	IO_L20P_6	P1	I/O
6	IO_L21N_6	N4	I/O
6	IO_L21P_6	P4	I/O
6	IO_L22N_6	N5	I/O
6	IO_L22P_6	M5	I/O
6	IO_L23N_6	M3	I/O
6	IO_L23P_6	M4	I/O
6	IO_L24N_6/VREF_6	N2	VREF
6	IO_L24P_6	M1	I/O
6	IO_L27N_6	L6	I/O
6	IO_L27P_6	L5	I/O
6	IO_L34N_6/VREF_6	L3	VREF
6	IO_L34P_6	L4	I/O
6	IO_L35N_6	L2	I/O
6	IO_L35P_6	L1	I/O
6	IO_L39N_6	K5	I/O
6	IO_L39P_6	K4	I/O
6	IO_L40N_6	K1	I/O
6	IO_L40P_6/VREF_6	K2	VREF
6	VCCO_6	K7	VCCO
6	VCCO_6	L7	VCCO
6	VCCO_6	N3	VCCO
7	IO	J6	I/O
7	IO_L01N_7/VRP_7	C3	DCI
7	IO_L01P_7/VRN_7	C2	DCI
7	IO_L16N_7	C1	I/O
7	IO_L16P_7/VREF_7	B1	VREF
7	IO_L17N_7	D1	I/O
7	IO_L17P_7	D2	I/O
7	IO_L19N_7/VREF_7	E3	VREF
7	IO_L19P_7	D3	I/O
7	IO_L20N_7	E2	I/O

Table 100: **FG456 Package Pinout *(Cont'd)***

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
3	IO_L16P_3	IO_L16P_3	Y22	I/O
3	IO_L17N_3	IO_L17N_3	V19	I/O
3	IO_L17P_3/VREF_3	IO_L17P_3/VREF_3	W19	VREF
3	IO_L19N_3	IO_L19N_3	W21	I/O
3	IO_L19P_3	IO_L19P_3	W20	I/O
3	IO_L20N_3	IO_L20N_3	U19	I/O
3	IO_L20P_3	IO_L20P_3	V20	I/O
3	IO_L21N_3	IO_L21N_3	V22	I/O
3	IO_L21P_3	IO_L21P_3	V21	I/O
3	IO_L22N_3	IO_L22N_3	T17	I/O
3	IO_L22P_3	IO_L22P_3	U18	I/O
3	IO_L23N_3	IO_L23N_3	U21	I/O
3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	U20	VREF
3	IO_L24N_3	IO_L24N_3	R18	I/O
3	IO_L24P_3	IO_L24P_3	T18	I/O
3	N.C. (◆)	IO_L26N_3	T20	I/O
3	N.C. (◆)	IO_L26P_3	T19	I/O
3	IO_L27N_3	IO_L27N_3	T22	I/O
3	IO_L27P_3	IO_L27P_3	T21	I/O
3	N.C. (◆)	IO_L28N_3	R22	I/O
3	N.C. (◆)	IO_L28P_3	R21	I/O
3	N.C. (◆)	IO_L29N_3	P19	I/O
3	N.C. (◆)	IO_L29P_3	R19	I/O
3	N.C. (◆)	IO_L31N_3	P18	I/O
3	N.C. (◆)	IO_L31P_3	P17	I/O
3	N.C. (◆)	IO_L32N_3	P22	I/O
3	N.C. (◆)	IO_L32P_3	P21	I/O
3	N.C. (◆)	IO_L33N_3	N18	I/O
3	N.C. (◆)	IO_L33P_3	N17	I/O
3	IO_L34N_3	IO_L34N_3	N20	I/O
3	IO_L34P_3/VREF_3	IO_L34P_3/VREF_3	N19	VREF
3	IO_L35N_3	IO_L35N_3	N22	I/O
3	IO_L35P_3	IO_L35P_3	N21	I/O
3	IO_L38N_3	IO_L38N_3	M18	I/O
3	IO_L38P_3	IO_L38P_3	M17	I/O
3	IO_L39N_3	IO_L39N_3	M20	I/O
3	IO_L39P_3	IO_L39P_3	M19	I/O
3	IO_L40N_3/VREF_3	IO_L40N_3/VREF_3	M22	VREF
3	IO_L40P_3	IO_L40P_3	M21	I/O
3	VCCO_3	VCCO_3	M16	VCCO

Table 100: **FG456 Package Pinout *(Cont'd)***

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
3	VCCO_3	VCCO_3	N16	VCCO
3	VCCO_3	VCCO_3	P16	VCCO
3	VCCO_3	VCCO_3	R17	VCCO
3	VCCO_3	VCCO_3	R20	VCCO
4	IO	IO	U16	I/O
4	IO	IO	U17	I/O
4	IO	IO	W13	I/O
4	IO	IO	W14	I/O
4	IO/VREF_4	IO/VREF_4	AB13	VREF
4	IO/VREF_4	IO/VREF_4	V18	VREF
4	IO/VREF_4	IO/VREF_4	Y16	VREF
4	IO_L01N_4/VRP_4	IO_L01N_4/VRP_4	AA20	DCI
4	IO_L01P_4/VRN_4	IO_L01P_4/VRN_4	AB20	DCI
4	N.C. (◆)	IO_L05N_4	AA19	I/O
4	N.C. (◆)	IO_L05P_4	AB19	I/O
4	IO_L06N_4/VREF_4	IO_L06N_4/VREF_4	W18	VREF
4	IO_L06P_4	IO_L06P_4	Y18	I/O
4	IO_L09N_4	IO_L09N_4	AA18	I/O
4	IO_L09P_4	IO_L09P_4	AB18	I/O
4	IO_L10N_4	IO_L10N_4	V17	I/O
4	IO_L10P_4	IO_L10P_4	W17	I/O
4	IO_L15N_4	IO_L15N_4	Y17	I/O
4	IO_L15P_4	IO_L15P_4	AA17	I/O
4	IO_L16N_4	IO_L16N_4	V16	I/O
4	IO_L16P_4	IO_L16P_4	W16	I/O
4	N.C. (◆)	IO_L19N_4	AA16	I/O
4	N.C. (◆)	IO_L19P_4	AB16	I/O
4	N.C. (◆)	IO_L22N_4/ VREF_4	V15	VREF
4	N.C. (◆)	IO_L22P_4	W15	I/O
4	IO_L24N_4	IO_L24N_4	AA15	I/O
4	IO_L24P_4	IO_L24P_4	AB15	I/O
4	IO_L25N_4	IO_L25N_4	U14	I/O
4	IO_L25P_4	IO_L25P_4	V14	I/O
4	IO_L27N_4/DIN/D0	IO_L27N_4/DIN/D0	AA14	DUAL
4	IO_L27P_4/D1	IO_L27P_4/D1	AB14	DUAL
4	IO_L28N_4	IO_L28N_4	U13	I/O
4	IO_L28P_4	IO_L28P_4	V13	I/O
4	IO_L29N_4	IO_L29N_4	Y13	I/O
4	IO_L29P_4	IO_L29P_4	AA13	I/O

Table 100: **FG456 Package Pinout *(Cont'd)***

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
4	IO_L30N_4/D2	IO_L30N_4/D2	U12	DUAL
4	IO_L30P_4/D3	IO_L30P_4/D3	V12	DUAL
4	IO_L31N_4/INIT_B	IO_L31N_4/INIT_B	W12	DUAL
4	IO_L31P_4/DOUT/BUSY	IO_L31P_4/DOUT/BUSY	Y12	DUAL
4	IO_L32N_4/GCLK1	IO_L32N_4/GCLK1	AA12	GCLK
4	IO_L32P_4/GCLK0	IO_L32P_4/GCLK0	AB12	GCLK
4	VCCO_4	VCCO_4	T12	VCCO
4	VCCO_4	VCCO_4	T13	VCCO
4	VCCO_4	VCCO_4	T14	VCCO
4	VCCO_4	VCCO_4	U15	VCCO
4	VCCO_4	VCCO_4	Y15	VCCO
5	IO	IO	U7	I/O
5	N.C. (◆)	IO	U9	I/O
5	IO	IO	U10	I/O
5	IO	IO	U11	I/O
5	IO	IO	V7	I/O
5	IO	IO	V10	I/O
5	IO/VREF_5	IO/VREF_5	AB11	VREF
5	IO/VREF_5	IO/VREF_5	U6	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	Y4	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	AA3	DUAL
5	IO_L06N_5	IO_L06N_5	AB4	I/O
5	IO_L06P_5	IO_L06P_5	AA4	I/O
5	IO_L09N_5	IO_L09N_5	Y5	I/O
5	IO_L09P_5	IO_L09P_5	W5	I/O
5	IO_L10N_5/VRP_5	IO_L10N_5/VRP_5	AB5	DCI
5	IO_L10P_5/VRN_5	IO_L10P_5/VRN_5	AA5	DCI
5	IO_L15N_5	IO_L15N_5	W6	I/O
5	IO_L15P_5	IO_L15P_5	V6	I/O
5	IO_L16N_5	IO_L16N_5	AA6	I/O
5	IO_L16P_5	IO_L16P_5	Y6	I/O
5	N.C. (◆)	IO_L19N_5	Y7	I/O
5	N.C. (◆)	IO_L19P_5/ VREF_5	W7	VREF
5	N.C. (◆)	IO_L22N_5	AB7	I/O
5	N.C. (◆)	IO_L22P_5	AA7	I/O
5	IO_L24N_5	IO_L24N_5	W8	I/O
5	IO_L24P_5	IO_L24P_5	V8	I/O
5	IO_L25N_5	IO_L25N_5	AB8	I/O
5	IO_L25P_5	IO_L25P_5	AA8	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
3	IO_L48P_3	IO_L48P_3	AB24	I/O
3	N.C. (◆)	IO_L49N_3	AA26	I/O
3	N.C. (◆)	IO_L49P_3	AA25	I/O
3	IO_L50N_3	IO_L50N_3	Y25	I/O
3	IO_L50P_3	IO_L50P_3	Y24	I/O
3	N.C. (◆)	IO_L51N_3	V24	I/O
3	N.C. (◆)	IO_L51P_3	W24	I/O
3	VCCO_3	VCCO_3	AA23	VCCO
3	VCCO_3	VCCO_3	AB23	VCCO
3	VCCO_3	VCCO_3	AB29	VCCO
3	VCCO_3	VCCO_3	AB33	VCCO
3	VCCO_3	VCCO_3	AD27	VCCO
3	VCCO_3	VCCO_3	AD31	VCCO
3	VCCO_3	VCCO_3	AG28	VCCO
3	VCCO_3	VCCO_3	AG32	VCCO
3	VCCO_3	VCCO_3	AL32	VCCO
3	VCCO_3	VCCO_3	W23	VCCO
3	VCCO_3	VCCO_3	W31	VCCO
3	VCCO_3	VCCO_3	Y23	VCCO
3	VCCO_3	VCCO_3	Y27	VCCO
4	IO	IO	AD18	I/O
4	IO	IO	AD19	I/O
4	IO	IO	AD20	I/O
4	IO	IO	AD22	I/O
4	IO	IO	AE18	I/O
4	IO	IO	AE19	I/O
4	IO	IO	AE22	I/O
4	N.C. (◆)	IO	AE24	I/O
4	IO	IO	AF24	I/O
4	N.C. (◆)	IO	AF26	I/O
4	IO	IO	AG26	I/O
4	IO	IO	AG27	I/O
4	IO	IO	AJ27	I/O
4	IO	IO	AJ29	I/O
4	IO	IO	AK25	I/O
4	IO	IO	AN26	I/O
4	IO/VREF_4	IO/VREF_4	AF21	VREF
4	IO/VREF_4	IO/VREF_4	AH23	VREF
4	IO/VREF_4	IO/VREF_4	AK18	VREF
4	IO/VREF_4	IO/VREF_4	AL30	VREF

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
4	VCCO_4	VCCO_4	AC19	VCCO
4	VCCO_4	VCCO_4	AC20	VCCO
4	VCCO_4	VCCO_4	AC21	VCCO
4	VCCO_4	VCCO_4	AC22	VCCO
4	VCCO_4	VCCO_4	AG20	VCCO
4	VCCO_4	VCCO_4	AG24	VCCO
4	VCCO_4	VCCO_4	AH27	VCCO
4	VCCO_4	VCCO_4	AJ22	VCCO
4	VCCO_4	VCCO_4	AL19	VCCO
4	VCCO_4	VCCO_4	AL24	VCCO
4	VCCO_4	VCCO_4	AM27	VCCO
4	VCCO_4	VCCO_4	AM31	VCCO
4	VCCO_4	VCCO_4	AN22	VCCO
5	IO	IO	AD11	I/O
5	N.C. (◆)	IO	AD12	I/O
5	IO	IO	AD14	I/O
5	IO	IO	AD15	I/O
5	IO	IO	AD16	I/O
5	IO	IO	AD17	I/O
5	IO	IO	AE14	I/O
5	IO	IO	AE16	I/O
5	N.C. (◆)	IO	AF9	I/O
5	IO	IO	AG9	I/O
5	IO	IO	AG12	I/O
5	IO	IO	AJ6	I/O
5	IO	IO	AJ17	I/O
5	IO	IO	AK10	I/O
5	IO	IO	AK14	I/O
5	IO	IO	AM12	I/O
5	IO	IO	AN9	I/O
5	IO/VREF_5	IO/VREF_5	AJ8	VREF
5	IO/VREF_5	IO/VREF_5	AL5	VREF
5	IO/VREF_5	IO/VREF_5	AP17	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	AP3	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	AN3	DUAL
5	IO_L02N_5	IO_L02N_5	AP4	I/O
5	IO_L02P_5	IO_L02P_5	AN4	I/O
5	IO_L03N_5	IO_L03N_5	AN5	I/O
5	IO_L03P_5	IO_L03P_5	AM5	I/O
5	IO_L04N_5	IO_L04N_5	AM6	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
5	IO_L04P_5	IO_L04P_5	AL6	I/O
5	IO_L05N_5	IO_L05N_5	AP6	I/O
5	IO_L05P_5	IO_L05P_5	AN6	I/O
5	IO_L06N_5	IO_L06N_5	AK7	I/O
5	IO_L06P_5	IO_L06P_5	AJ7	I/O
5	IO_L07N_5	IO_L07N_5	AG10	I/O
5	IO_L07P_5	IO_L07P_5	AF10	I/O
5	IO_L08N_5	IO_L08N_5	AJ10	I/O
5	IO_L08P_5	IO_L08P_5	AH10	I/O
5	IO_L09N_5	IO_L09N_5	AM10	I/O
5	IO_L09P_5	IO_L09P_5	AL10	I/O
5	IO_L10N_5/VRP_5	IO_L10N_5/VRP_5	AP10	DCI
5	IO_L10P_5/VRN_5	IO_L10P_5/VRN_5	AN10	DCI
5	IO_L11N_5/VREF_5	IO_L11N_5/VREF_5	AP11	VREF
5	IO_L11P_5	IO_L11P_5	AN11	I/O
5	IO_L12N_5	IO_L12N_5	AF12	I/O
5	IO_L12P_5	IO_L12P_5	AE12	I/O
5	IO_L13N_5	IO_L13N_5	AJ12	I/O
5	IO_L13P_5	IO_L13P_5	AH12	I/O
5	IO_L14N_5	IO_L14N_5	AL12	I/O
5	IO_L14P_5	IO_L14P_5	AK12	I/O
5	IO_L15N_5	IO_L15N_5	AP12	I/O
5	IO_L15P_5	IO_L15P_5	AN12	I/O
5	IO_L16N_5	IO_L16N_5	AE13	I/O
5	IO_L16P_5	IO_L16P_5	AD13	I/O
5	IO_L17N_5	IO_L17N_5	AH13	I/O
5	IO_L17P_5	IO_L17P_5	AG13	I/O
5	IO_L18N_5	IO_L18N_5	AM13	I/O
5	IO_L18P_5	IO_L18P_5	AL13	I/O
5	IO_L19N_5	IO_L19N_5	AG14	I/O
5	IO_L19P_5/VREF_5	IO_L19P_5/VREF_5	AF14	VREF
5	IO_L20N_5	IO_L20N_5	AJ14	I/O
5	IO_L20P_5	IO_L20P_5	AH14	I/O
5	IO_L21N_5	IO_L21N_5	AM14	I/O
5	IO_L21P_5	IO_L21P_5	AL14	I/O
5	IO_L22N_5	IO_L22N_5	AP14	I/O
5	IO_L22P_5	IO_L22P_5	AN14	I/O
5	IO_L23N_5	IO_L23N_5	AF15	I/O
5	IO_L23P_5	IO_L23P_5	AE15	I/O
5	IO_L24N_5	IO_L24N_5	AJ15	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
6	IO_L37N_6	IO_L37N_6	W3	I/O
6	IO_L37P_6	IO_L37P_6	W2	I/O
6	IO_L38N_6	IO_L38N_6	V6	I/O
6	IO_L38P_6	IO_L38P_6	V5	I/O
6	IO_L39N_6	IO_L39N_6	V4	I/O
6	IO_L39P_6	IO_L39P_6	V3	I/O
6	IO_L40N_6	IO_L40N_6	V2	I/O
6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	V1	VREF
6	N.C. (◆)	IO_L41N_6	AH4	I/O
6	N.C. (◆)	IO_L41P_6	AH3	I/O
6	N.C. (◆)	IO_L44N_6	AD7	I/O
6	N.C. (◆)	IO_L44P_6	AD6	I/O
6	IO_L45N_6	IO_L45N_6	AC4	I/O
6	IO_L45P_6	IO_L45P_6	AC3	I/O
6	N.C. (◆)	IO_L46N_6	AA10	I/O
6	N.C. (◆)	IO_L46P_6	AA9	I/O
6	IO_L48N_6	IO_L48N_6	Y7	I/O
6	IO_L48P_6	IO_L48P_6	Y6	I/O
6	N.C. (◆)	IO_L49N_6	W11	I/O
6	N.C. (◆)	IO_L49P_6	V11	I/O
6	IO_L52N_6	IO_L52N_6	V8	I/O
6	IO_L52P_6	IO_L52P_6	V7	I/O
6	VCCO_6	VCCO_6	AA12	VCCO
6	VCCO_6	VCCO_6	AB12	VCCO
6	VCCO_6	VCCO_6	AB2	VCCO
6	VCCO_6	VCCO_6	AB6	VCCO
6	VCCO_6	VCCO_6	AD4	VCCO
6	VCCO_6	VCCO_6	AD8	VCCO
6	VCCO_6	VCCO_6	AG3	VCCO
6	VCCO_6	VCCO_6	AG7	VCCO
6	VCCO_6	VCCO_6	AL3	VCCO
6	VCCO_6	VCCO_6	W12	VCCO
6	VCCO_6	VCCO_6	W4	VCCO
6	VCCO_6	VCCO_6	Y12	VCCO
6	VCCO_6	VCCO_6	Y8	VCCO
7	IO	IO	G1	I/O
7	IO	IO	G2	I/O
7	IO	IO	U10	I/O
7	IO	IO	U9	I/O
7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	C1	DCI

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
N/A	VCCINT	VCCINT	Y22	VCCINT
VCCAUX	CCLK	CCLK	AL31	CONFIG
VCCAUX	DONE	DONE	AD24	CONFIG
VCCAUX	HSWAP_EN	HSWAP_EN	L11	CONFIG
VCCAUX	M0	M0	AL4	CONFIG
VCCAUX	M1	M1	AK4	CONFIG
VCCAUX	M2	M2	AG8	CONFIG
VCCAUX	PROG_B	PROG_B	D4	CONFIG
VCCAUX	TCK	TCK	D31	JTAG
VCCAUX	TDI	TDI	E4	JTAG
VCCAUX	TDO	TDO	E31	JTAG
VCCAUX	TMS	TMS	H27	JTAG

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17
V	I/O L40P_6 VREF_6	I/O L40N_6	I/O L39P_6	I/O L39N_6	I/O L38P_6	I/O L38N_6	I/O L52P_6	I/O L52N_6	I/O	I/O	I/O L49P_6 ◆	VCCINT	GND	GND	GND	GND	GND
W	GND	I/O L37P_6	I/O L37N_6	VCCO_6	GND	I/O L36P_6	I/O L36N_6	VCCAUX	GND	I/O L35P_6	I/O L49N_6 ◆	VCCO_6	VCCINT	GND	GND	GND	GND
Y	I/O L34P_6	I/O L34N_6 VREF_6	I/O L33P_6	I/O L33N_6	VCCAUX	I/O L48P_6	I/O L48N_6	VCCO_6	I/O L35N_6	I/O L32P_6	I/O L32N_6	VCCO_6	VCCINT	GND	GND	GND	GND
AA	I/O L31P_6	I/O L31N_6	I/O L30P_6	I/O L30N_6	I/O L29P_6	I/O L29N_6	I/O L28P_6	I/O L28N_6	I/O L46P_6 ◆	I/O L46N_6 ◆	I/O L27P_6	VCCO_6	VCCINT	GND	GND	GND	GND
AB	GND	VCCO_6	I/O L26P_6	I/O L26N_6	GND	VCCO_6	I/O L25P_6	I/O L25N_6	GND	I/O L24P_6	I/O L27N_6	VCCO_6	VCCINT	VCCINT	VCCINT	VCCINT	GND
AC	I/O L23P_6	I/O L23N_6	I/O L45P_6	I/O L45N_6	I/O L22P_6	I/O L22N_6	I/O L21P_6	I/O L21N_6	I/O L24N_6 VREF_6	I/O L20P_6	I/O L20N_6	VCCINT	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCINT
AD	I/O L19P_6	I/O L19N_6	GND	VCCO_6	VCCAUX	I/O L44P_6 ◆	I/O L44N_6 ◆	VCCO_6	I/O L17P_6 VREF_6	I/O L17N_6	I/O	I/O ◆	I/O L16P_5	I/O	I/O	I/O	I/O
AE	I/O L16P_6	I/O L16N_6	I/O L15P_6	I/O L15N_6	I/O L14P_6	I/O L14N_6	I/O L13P_6 VREF_6	I/O L13N_6	I/O L12P_6	GND	I/O L39P_5 ◆	I/O L12P_5	I/O L16N_5	I/O	I/O L23P_5	I/O	I/O L29P_5 VREF_5
AF	GND	I/O L11P_6	I/O L11N_6	I/O L10P_6	GND	I/O L09P_6	I/O L09N_6 VREF_6	I/O L12N_6	I/O ◆	I/O L07P_5	I/O L39N_5 ◆	I/O L12N_5	GND	I/O L19P_5 VREF_5	I/O L23N_5	GND	I/O L29N_5
AG	I/O L08P_6	I/O L08N_6	VCCO_6	I/O L10N_6	I/O L07P_6	I/O L07N_6	VCCO_6	M2	I/O	I/O L07N_5	VCCO_5	I/O	I/O L17P_5	I/O L19N_5	VCCO_5	VCCAUX	I/O L30P_5
AH	I/O	I/O	I/O L41P_6 ◆	I/O L41N_6 ◆	I/O L06P_6	I/O L06N_6	GND	VCCO_5	I/O L37P_5	I/O L08P_5	I/O L40P_5 ◆	I/O L13P_5	I/O L17N_5	I/O L20P_5	I/O L24P_5	I/O L27P_5	I/O L30N_5
AJ	I/O L05P_6	I/O L05N_6	I/O L04P_6	I/O L04N_6	VCCAUX	I/O	I/O L06P_5	IO VREF_5	I/O L37N_5	I/O L08N_5	I/O L40N_5 ◆	I/O L13N_5	VCCO_5	I/O L20N_5	I/O L24N_5	I/O L27N_5 VREF_5	I/O
AK	GND	I/O L03P_6	I/O L03N_6 VREF_6	M1	GND	VCCAUX	I/O L06N_5	I/O L35P_5	GND	I/O	VCCAUX	I/O L14P_5	GND	I/O	VCCAUX	GND	I/O L31P_5 D5
AL	I/O L02P_6	I/O L02N_6	VCCO_6	M0	IO VREF_5	I/O L04P_5	I/O L33P_5 ◆	I/O L35N_5	I/O L38P_5	I/O L09P_5	VCCO_5	I/O L14N_5	I/O L18P_5	I/O L21P_5	I/O L25P_5	VCCO_5	I/O L31N_5 D4
AM	I/O L01P_6 VRN_6	I/O L01N_6 VRP_6	GND	VCCO_5	I/O L03P_5	I/O L04N_5	I/O L33N_5 ◆	VCCO_5	I/O L38N_5	I/O L09N_5	GND	I/O	I/O L18N_5	I/O L21N_5	I/O L25N_5	I/O L28P_5 D7	I/O L32P_5 GCLK2
AN	GND	GND	I/O L01P_5 CS_B	I/O L02P_5	I/O L03N_5	I/O L05P_5	I/O L34P_5 ◆	I/O L36P_5	I/O	I/O L10P_5 VRN_5	I/O L11P_5	I/O L15P_5	VCCO_5	I/O L22P_5	I/O L26P_5	I/O L28N_5 D6	I/O L32N_5 GCLK3
AP	GND	GND	I/O L01N_5 RDWR_B	I/O L02N_5	GND	I/O L05N_5	I/O L34N_5 ◆	I/O L36N_5	GND	I/O L10N_5 VRP_5	I/O L11N_5 VREF_5	I/O L15N_5	GND	I/O L22N_5	I/O L26N_5	GND	IO VREF_5

Bank 6

Bank 5

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Bottom Left Corner of FG1156 Package (Top View)

Figure 59: FG1156 Package Footprint (Top View) Continued